USIXF SERIES

SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER

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US1AF THRU US1MF

SURFACE MOUNT ULTRAFAST RECOVERY RECTIFIER



REVERSE VOLTAGE: 50 to 1000 VOLTS FORWARD CURRENT: 1.0 AMPERE

FEATURES

· Plastic package has Underwriters Laboratory Flammability Classification 94V-O

- · For surface mounted applications
- · Low profile package
- · Easy pick and place
- · Built-in strain relief
- · Ultrafast recovery times for high efficiency
- \cdot High temperature soldering : 250°C /10 seconds at terminals

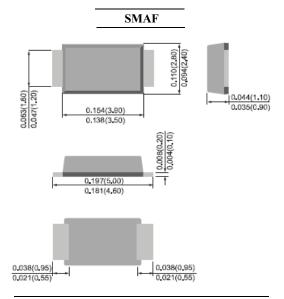
MECHANICAL DATA

Case: Molded plastic, SMAF

Terminals: Solder plated, solderable per MIL-STD-750,

method 2026 guaranteed

Polarity: Color band denotes cathode end Packaging: 12mm tape per EIA STD RS-481



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, $60H_Z$, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	US1AF	US1BF	US1DF	US1GF	US1JF	US1KF	US1MF	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current See Fig.1	I _(AV)				1.0				Amp
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I _{FSM} 30							Amp	
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage at 1.0A	$V_{\rm F}$		1.0		1.3		1.7		Volts
Maximum Reverse Current at T_A =25°C at Rated DC Blocking Voltage T_A =125°C	I_R	5.0 100							μАтр
Typical Junction Capacitance (Note 1)	C_{J}	17							pF
Typical Thermal Resistance (Note 2)	$R_{\theta JA}$	80							°C/W
Maximum Reverse Recovery Time (Note 3)	T _{RR}	50 75						nS	
Operating Junction Temperature Range	$T_{\mathbf{J}}$	-55 to +150							°C
Storage Temperature Range	Tstg	-55 to +150							ဗ

NOTES:

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal resistance from junction to ambient mounted on P.C.B. with 5.0 x 5.0mm copper pad areas
- 3- Reverse Recovery Test Conditions: I_F =.5A, I_R =1A, I_{RR} =.25A.

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RATINGS AND CHARACTERISTIC CURVES

Fig.1 Forward Current Derating Curve

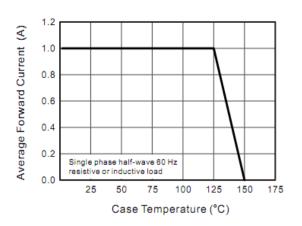


Fig.3 Typical Forward Characteristics

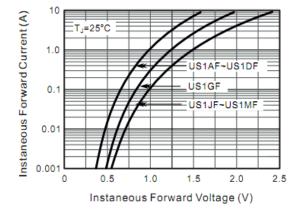


Fig.2 Typical Reverse Characteristics

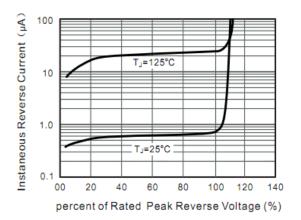


Fig.4 Maximum Non-Repetitive Peak Forward Surage Current

